

24-BIT BUS EXCHANGE SWITCH

### FEATURES:

- Bus switches provide zero delay paths
- Extended commercial range of -40°C to +85°C
- Low switch on-resistance:  $4\Omega$
- TTL-compatible input and output levels
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- Available in SSOP, TSSOP, and TVSOP Packages

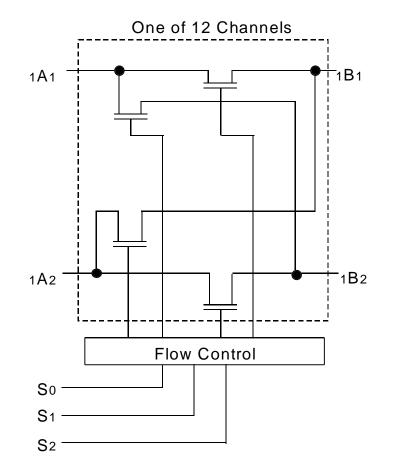
### **DESCRIPTION:**

The FST163212 belongs to IDT's family of Bus switches. Bus switch devices perform the function of connecting or isolating two ports without providing any inherent current sink or source capability. Thus they generate little or no noise of their own while providing a low resistance path for an external driver. These devices connect input and output ports through an n-channel FET. When the gate-to-source junction of this FET is adequately forward-biased the device conducts and the resistance between input and output ports is small. Without adequate bias on the gate-to-source junction of the FET, the FET is turned off, therefore with no Vcc applied, the device has hot insertion capability.

The low on-resistance and simplicity of the connection between input and output ports reduces the delay in this path to close to zero.

The FST163212 provides four 12-bit TTL- compatible ports that support 2 way bus exchange. The S0-2 pins control the bus exchange and switch enable functions.

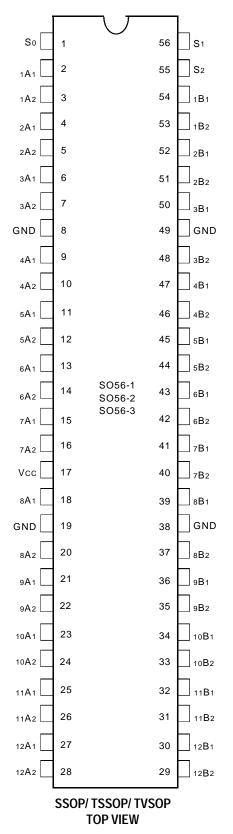
## **FUNCTIONAL BLOCK DIAGRAM**



### INDUSTRIAL TEMPERATURE RANGE

### OCTOBER 1999

### **PIN CONFIGURATION**



#### **INDUSTRIAL TEMPERATURE RANGE**

## ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Rating	Max.	Unit
VTERM <sup>(2)</sup>	Terminal Voltage with Respect to GND	–0.5 to +7	V
Tstg	Storage Temperature	-65 to +150	°C
Ιουτ	Maximum Continuous Channel Current	128	mA
			FST LINK

NOTES:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Vcc, Control, and Switch terminals.

### CAPACITANCE (1)

Symbol	Parameter	Conditions <sup>(2)</sup>	Тур.	Unit
CIN	Control Input Capacitance		6	pF
Сі/о	Switch Input/Output Capacitance	Switch Off	17	pF

NOTES:

1. Capacitance is characterized but not tested.

2. TA =  $25^{\circ}$ C, f = 1MHz, VIN = 0V, VOUT = 0V

## **PIN DESCRIPTION**

Pin Names	I/O	Description
A1, A2	I/O	Buses A1, A2, B1, B2
B1, B2		
S0-2	I	Control Pins for Mux and Switch
		Enable Functions

### FUNCTION TABLE (1)

S2	S1	S0	<b>A</b> 1	A2	Function
L	L	L	Z	Z	Disconnect
L	L	Н	<b>B</b> 1	Z	A1 to B1
L	Н	L	B2	Z	A1 to B2
L	Н	Н	Z	<b>B</b> 1	A2 to B1
Н	L	L	Z	B2	A2 to B2
Н	L	Н	Z	Z	Disconnect
Н	Н	L	B1	B2	A1 to B1, A2 to B2
Н	Н	Н	B2	<b>B</b> 1	A1 to B2, A2 to B1

NOTE:

1. H = HIGH Voltage level

L = LOW Voltage Level Z = High-Impedence

# DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: Operating Conditions: TA =  $-40^{\circ}$ C to  $+85^{\circ}$ C, Vcc =  $5.0V \pm 10\%$ 

Symbol	Parameter	Test Conditions		Min.	Typ. <sup>(1)</sup>	Max.	Unit
VIH	Control Input HIGH Voltage	Guaranteed Logic I	HIGH for Control Inputs	2	_	—	V
VIL	Control Input LOW Voltage	Guaranteed Logic LOW for Control Inputs		_	—	0.8	V
Ін	Control Input HIGH Current	Vcc = Max.	VI = VCC	_	—	±1	μA
lil	Control Input LOW Current		VI = GND	_	_	±1	
Іоzн	Current during	Vcc = Max., Vo = 0 to 5V		_	—	±1	μA
Iozl	Bus Switch DISCONNECT			_	_	±1	
Vik	Clamp Diode Voltage	Vcc = Min., In = -18mA		_	-0.7	-1.2	V
IOFF	Switch Power Off Leakage	Vcc = 0V, VIN or Vo $\leq 5.5$ V		_	—	±1	μA
lcc	Quiescent Power Supply Current	Vcc = Max., Vin = GND or Vcc		_	0.1	3	μA

## **BUS SWITCH IMPEDANCE OVER OPERATING RANGE**

Following Conditions Apply Unless Otherwise Specified: Operating Conditions: TA =  $-40^{\circ}$ C to  $+85^{\circ}$ C, Vcc =  $5.0V \pm 10\%$ 

Symbol	Parameter	Test Conditions	Min.	Тур. <sup>(1)</sup>	Max.	Unit
Ron	Switch On Resistance <sup>(2)</sup>	Vcc = Min., VIN = 0V	_	4	7	Ω
		ION = 64mA				
		Vcc = Min., VIN = 0V	_	4	7	Ω
		$I_{ON} = 30 \text{mA}$				
		Vcc = Min., VIN = 2.4V	_	10	15	Ω
		Ion = 15mA				
los	Short Circuit Current, A to B <sup>(3)</sup>	A(B) = 0V, B(A) = VCC	100	—		mA

NOTES:

1. Typical values are at Vcc = 5.0V, +25°C ambient.

2. The voltage drop between the indicated ports divided by the current through the switch.

3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.

# **POWER SUPPLY CHARACTERISTICS**

Symbol	Parameter	Test Co	onditions <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Unit
ΔΙcc	Quiescent Power Supply Current TTL Inputs HIGH	$V_{CC} = Max.$ $V_{IN} = 3.4V^{(3)}$		-	0.5	1.5	mA
Ісср	Dynamic Power Supply Current <sup>(4, 5)</sup>	Vcc = Max. Outputs Open Select Pin Toggling 50% Duty Cycle	VIN = VCC VIN = GND	_	30	40	μΑ/ MHz/ Select
lc	Total Power Supply Current <sup>(6)</sup>	V <sub>CC</sub> = Max. Outputs Open Select Pins Toggling	VIN = VCC VIN = GND	-	7.2	9.6	mA
		(24 Switches Toggling) fi = 10MHz 50% Duty Cycle	VIN = 3.4 VIN = GND	_	7.7	11.1	

NOTES:

1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.  $T_A = -40^{\circ}C$  to +85°C

2. Typical values are at Vcc = 5.0V, +25°C ambient.

3. Per TTL driven input (VIN = 3.4V). All other inputs at Vcc or GND. Switch inputs do not contribute to  $\Delta$ Icc.

4. This parameter represents the current required to switch the internal capacitance of the control inputs at the specified frequency. Switch inputs generate no significant power supply currents as they transition. This parameter is not directly testable, but is derived for use in Total

Switch inputs generate no significant power supply currents as they transition. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.

5. CPD = ICCD/VCC

CPD = Power Dissipation Capacitance

6. IC = IQUIESCENT + INPUTS + IDYNAMIC

 $Ic = Icc + \Delta Icc DHNT + IccD$  (fiN)

Icc = Quiescent Current

 $\Delta$ Icc = Power Supply Current for a TTL High Input (VIN = 3.4V)

DH = Duty Cycle for TTL Inputs High

NT = Number of TTL Inputs at DH

ICCD = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)

fi = Control Input Frequency

N = Number of Control Inputs Toggling at fi

# SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: Operating Conditions: TA =  $-40^{\circ}$ C to  $+85^{\circ}$ C, V<sub>CC</sub> =  $5.0V \pm 10\%$ 

			$Vcc = 5V \pm 10\%$			
Symbol	Description <sup>(1)</sup>	Min.	Тур.	Max.	Max.	Unit
tplh tphl	Data Propagation Delay A to B, B to A <sup>(2)</sup>	_	—	0.25	0.25	ns
tвx	Switch Multiplex Delay S to A, B	1.5	—	6.5	7	ns
tpzh tpzl	Switch Turn on Delay S to A, B	1.5	_	6.5	7	ns
tphz tplz	Switch Turn off Delay S to A, B	1.5	_	7	7	ns
Qcı	Charge Injection During Switch DISCONNECT, S to A or B <sup>(3)</sup>	_	1.5	_	_	рС
Qdci	Charge Injection During Switch Exchange, S to A or B <sup>(3)</sup>	_	0.5	_	_	

#### NOTES:

1. See test circuits and waveforms.

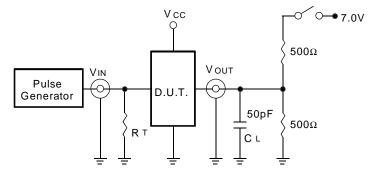
2. The bus switch contributes no Propagation Delay other than the RC Delay of the load interacting with the RC of the switch.

|QCI| is the charge injection for a single switch DISCONNECT and applies to either single switches or multiplexers.
|QDCI| is the charge injection for a multiplexer as the multiplexed port switches from one path to another. Charge injection is reduced because the injection from the DISCONNECT of the first path is compensated by the CONNECT of the second path.

#### IDT74FST163212 24-BIT BUS EXCHANGE SWITCH

## **TEST CIRCUITS AND WAVEFORMS**

### **TEST CIRCUITS FOR ALL OUTPUTS**



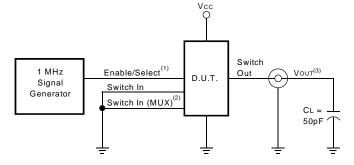
### **SWITCH POSITION**

Test	Switch
Open Drain	
Disable Low	Closed
Enable Low	
All Other Tests	Open
	FCT LINK

#### DEFINITIONS:

- CL = Load capacitance: includes jig and probe capacitance.
- RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.

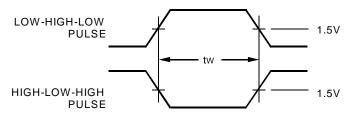
# **CHARGE INJECTION**



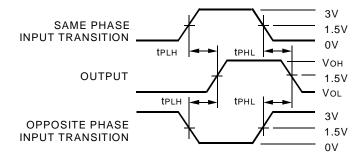
#### NOTES:

- 1. Select is used with multiplexers for measuring IQDCII during multiplexer select. During all other tests Enable is used.
- 2. Used with multiplexers to measure IQDCII only.
- 3. Charge Injection =  $\Delta$ Vout CL, with Enable toggling for IQcII or Select toggling for IQDCII.  $\Delta$ Vout is the change in Vout and is measured with a 10M $\Omega$  probe.

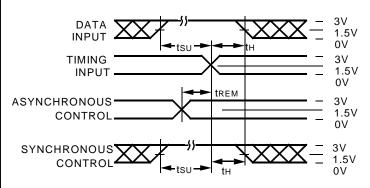
### **PULSE WIDTH**



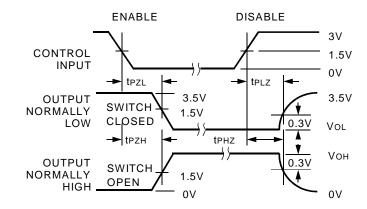
## **PROPAGATION DELAY**



# SET-UP, HOLD, AND RELEASE TIMES



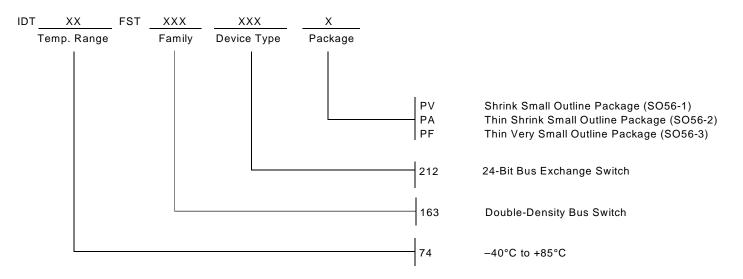
# **ENABLE AND DISABLE TIMES**



### NOTES:

- 1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH
- 2. Pulse Generator for All Pulses: Rate  $\leq$  1.0MHz; tF  $\leq$  2.5ns; tR  $\leq$  2.5ns

## **ORDERING INFORMATION**





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